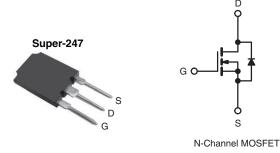
Vishay Siliconix



Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	600			
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.110			
Q _g (Max.) (nC)	330			
Q _{gs} (nC)	84			
Q _{gd} (nC)	150			
Configuration	Single			

FEATURES

- \bullet Low gate charge Q_{g} results in simple drive requirement
- Improved gate, avalanche and dynamic dV/dt



COMPLIANT

HALOGEN FREE

- ruggedness and
- Fully characterized capacitance avalanche voltage and current
- Enhanced body diode dV/dt capability
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Hard switching primary or PFC switch
- Switch mode power supply (SMPS)
- Uninterruptible power supply
- High speed power switching
- Motor drive

ORDERING INFORMATION	
Package	Super-247
Lead (Pb)-free and halogen-free	SiHFPS40N60K-GE3

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	600	v
Gate-source voltage			V _{GS}	± 30	v
$T_{\rm C} = 25 ^{\circ}{\rm C}$			40		
Continuous drain current	V _{GS} at 10 V	T _C = 100 °C	ID	24	A
Pulsed drain current ^a			I _{DM}	160	
Linear derating factor				4.5	W/°C
Single pulse avalanche energy ^b			E _{AS}	600	mJ
Repetitive avalanche current ^a			I _{AR}	40	А
Repetitive avalanche energy ^a			E _{AR}	57	mJ
Maximum power dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			PD	570	W
Peak diode recovery dV/dt ^c			dV/dt	7.5	V/ns
Operating junction and storage temperature range			T _J , T _{stg}	- 55 to + 150	°C
Soldering recommendations (peak temperature) for 10 s				300 ^d	-0

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11) b. Starting T_J = 25 °C, L = 0.84 mH, R_g = 25 Ω , I_{AS} = 38 A, dV/dt = 5.5 V/ns (see fig. 12a) c. I_{SD} ≤ 38 A, dI/dt ≤ 150 A/µs, V_{DD} ≤ V_{DS}, T_J ≤ 150 °C

d. 1.6 mm from case

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	40	
Case-to-sink, flat, greased surface	R _{thCS}	0.24	-	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	0.22	

S21-0019-Rev. C, 18-Jan-2021



Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		• •					•
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 µA		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referen	ce to 25 °C, I _D = 1 mA	-	0.63	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS}	= V _{GS} , I _D = 250 μΑ	3.0	-	5.0	V
Gate-source leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 100	nA
Zaus asta valta sa shusia sumant	1	V _{DS}	= 600 V, V _{GS} = 0 V	-	-	50	<u>† </u>
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	/, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 24 A ^b	-	0.110	0.130	Ω
Forward transconductance	g _{fs}	V _{DS}	= 50 V, I _D = 24 A ^b	21	-	-	S
Dynamic		•					•
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	7970	-	
Output capacitance	C _{oss}		$V_{DS} = 25 V,$	-	750	-	- pF
Reverse transfer capacitance	C _{rss}	f = 1	.0 MHz, see fig. 5	-	75	-	
			V _{DS} = 1.0 V, f = 1.0 MHz	-	9440	-	
Output capacitance	C _{oss}	V _{GS} = 0 V V _{DS} = 480 V, f = 1.0 MHz		-	200	-]
Effective output capacitance	C _{oss} eff.		V_{DS} = 0 V to 480 V ^c	-	260	-]
Total gate charge	Qg			-	-	330	
Gate-source charge	Q _{gs}		$I_{\rm D}$ = 38 A, $V_{\rm DS}$ = 480 V, see fig. 6 and 13 ^b		-	84	nC
Gate-drain charge	Q _{gd}		eee ngi e ana te	-	-	150	
Turn-on delay time	t _{d(on)}	$V_{GS} = 10 V$		-	47	-	
Rise time	t _r		V _{DD} = 300 V, I _D = 38 A,	-	110	-	ns
Turn-off delay time	t _{d(off)}		$R_G = 4.3 \Omega$, see fig. 10 ^b	-	97	-	
Fall time	t _f			-	60	-	
Drain-source body diode characteristic	S						
Continuous source-drain diode current	I _S	showing the	MOSFET symbol showing the		-	40	А
Pulsed diode forward current ^a	I _{SM}	p - n junction diode		-	-	160	
Body diode voltage	V _{SD}	$T_{\rm J}$ = 25 °C, $I_{\rm S}$ = 38 A, $V_{\rm GS}$ = 0 V ^b		-	-	1.5	V
		T _J = 25 °C		-	630	950	
Body diode reverse recovery time	t _{rr}	T _J = 125 °C	I _F = 38 A, dl/dt = 100	-	730	1090	ns
Podu diada rayaraa raaayar ahara-			-	14	20		
Douy aloue reverse recovery charge			-	17	25	μC	
Body diode recovery current	I _{RRM}	T _J = 25 °C		-	39	58	Α
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)			L _D)		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}



Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

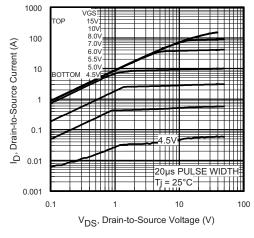


Fig. 1 - Typical Output Characteristics

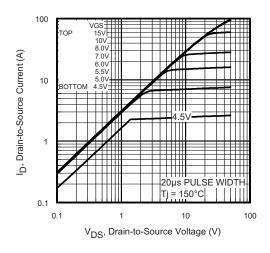


Fig. 2 - Typical Output Characteristics

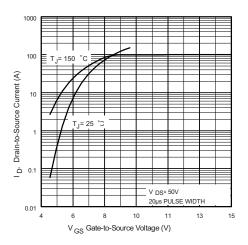


Fig. 3 - Typical Transfer Characteristics

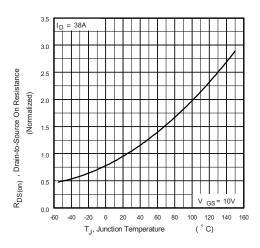


Fig. 4 - Normalized On-Resistance vs. Temperature

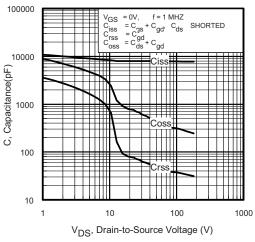


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

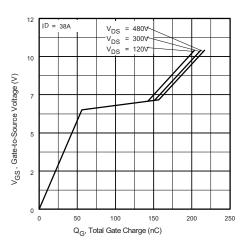


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

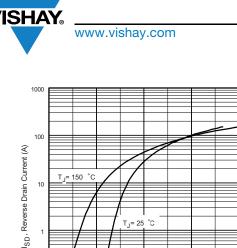
S21-0019-Rev. C, 18-Jan-2021

3 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91261

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



Vishay Siliconix



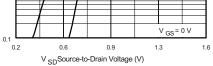


Fig. 7 - Typical Source-Drain Diode Forward Voltage

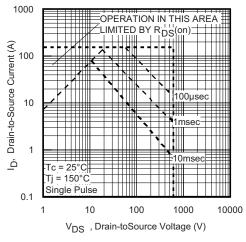


Fig. 8 - Maximum Safe Operating Area

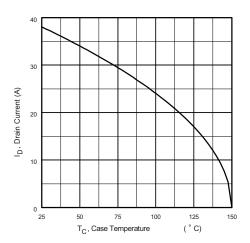


Fig. 9 - Maximum Drain Current vs. Case Temperature

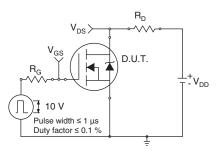


Fig. 10a - Switching Time Test Circuit

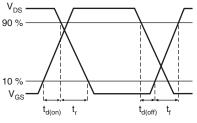


Fig. 10b - Switching Time Waveforms

4

Vishay Siliconix

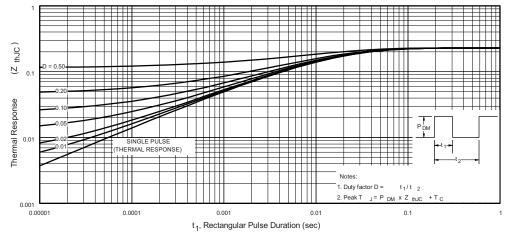
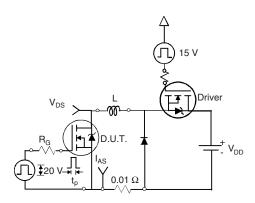


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



www.vishay.com

Fig. 12a - Unclamped Inductive Test Circuit

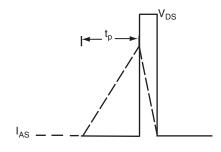


Fig. 12b - Unclamped Inductive Waveforms

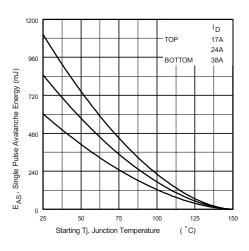


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

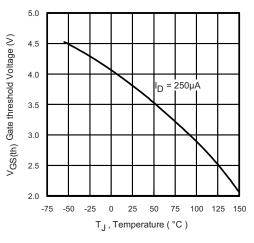
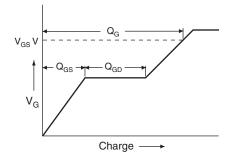


Fig. 12d - Threshold Voltage vs. Temperature

For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



Vishay Siliconix



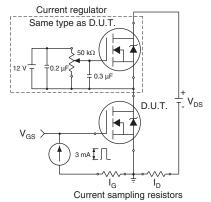


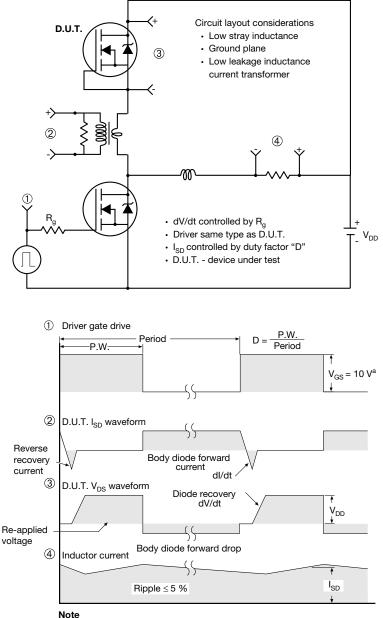
Fig. 13a - Basic Gate Charge Waveform

Fig. 13b - Gate Charge Test Circuit

Vishay Siliconix



Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

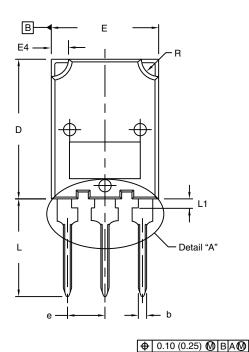
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91261.



Vishay Siliconix

TO-274AA (High Voltage)

VERSION 1: FACILITY CODE = Y



100

MILLIMETERS

MAX.

5.30

2.50

2.65

1.60

2.20

3.25

0.89

20.80

MIN.

4.70

1.50

2.25

1.30

1.80

0.38

19.80

5°.

DIM.

А

A1 A2

b

b2

b4 c ⁽¹⁾

D

Þ

Lead Tip

INCHES

MAX.

0.209

0.098

0.104

0.063

0.087

0.128

0.035

0.819

MIN.

0.185

0.059

0.089

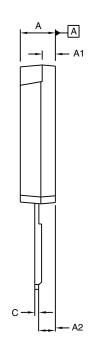
0.051

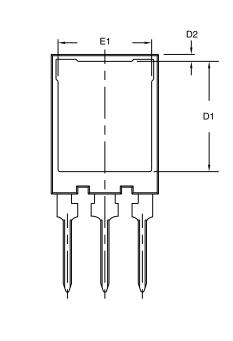
0.071

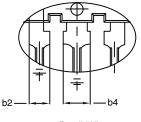
0.118

0.015

0.780







Detail "A" Scale: 2:1

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D1	15.50	16.10	0.610	0.634
D2	0.70	1.30	0.028	0.051
E	15.10	16.10	0.594	0.634
E1	13.30	13.90	0.524	0.547
е	5.45 BSC		0.215	BSC
L	13.70	14.70	0.539	0.579
L1	1.00	1.60	0.039	0.063
R	2.00	3.00	0.079	0.118

Notes

Dimensioning and tolerancing per ASME Y14.5M-1994

• Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outer extremes of the plastic body

• Outline conforms to JEDEC® outline to TO-274AA

⁽¹⁾ Dimension measured at tip of lead

Revision:	19-Oct-2020
-----------	-------------

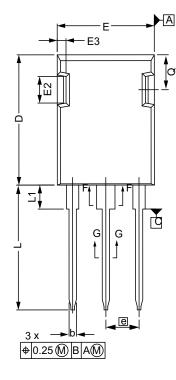
1

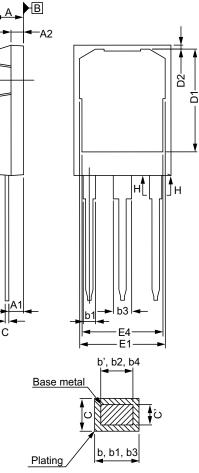
For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



Vishay Siliconix

VERSION 2: FACILITY CODE = N





SECTION "F-F", "G-G" AND "H-H" SCALE: NONE

	MILLIMETERS		
DIM.	MIN.	MAX.	
D1	16.25	17.65	
D2	0.50	0.80	
E	15.75	16.13	
E1	13.10	14.15	
E2	3.68	5.10	
E3	1.00	1.90	
E4	12.38	13.43	
е	5.44	BSC	
N	3	3	
L	19.81	20.32	
L1	3.70	4.00	
Q	5.49	6.00	

	MILLIMETERS		
DIM.	MIN.	MAX.	
А	4.83	5.21	
A1	2.29	2.54	
A2	1.91	2.16	
b'	1.07	1.28	
b	1.07	1.33	
b1	1.91	2.41	
b2	1.91	2.16	
b3	2.87	3.38	
b4	2.87	3.13	
C'	0.55	0.65	
С	0.55	0.68	
D	20.80	21.10	
_	Rev. C, 19-Oct-2020		

DWG: 5975

Notes

Dimensioning and tolerancing per ASME Y14.5M-1994 Outline conforms to JEDEC[®] outline to TO-274AD Dimensions are measured in mm, angles are in degree •

•

٠

Metal surfaces are tin plated, except area of cut •

Revision: 19-Oct-2020

2



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2025 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED

Revision: 01-Jan-2025

1